DISCRETE SEMICONDUCTORS

DATA SHEET

PIMH9; PUMH9; PEMH9 NPN/NPN resistor-equipped transistors; R1 = 10 kΩ, R2 = 47 kΩ

Product data sheet Supersedes data of 2003 Sep 15 2004 Apr 14



NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

PIMH9; PUMH9; PEMH9

FEATURES

- Built-in bias resistors
- Simplifies circuit design
- · Reduces component count
- · Reduces pick and place costs.

APPLICATIONS

- · General purpose switching and amplification
- · Inverter and interface circuits
- · Circuit driver.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V_{CEO}	collector-emitter voltage	_	50	V
Io	output current (DC)	_	100	mA
TR1	NPN	_	-	-
TR2	NPN	_	_	_
R1	bias resistor	10		kΩ
R2	bias resistor	47	_	kΩ

DESCRIPTION

NPN/NPN resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

PRODUCT OVERVIEW

TYPE NUMBER	PACKAGE		MARKING CODE	PNP/PNP	NPN/PNP	
TIPE NOWIBER	PHILIPS	EIAJ	WARKING CODE	COMPLEMENT	COMPLEMENT	
РЕМН9	SOT666	-	H9	PEMB9	PEMD9	
PIMH9	SOT457	SC-74	H9	_	_	
PUMH9	SOT363	SC-88	H*9 ⁽¹⁾	PUMB9	PUMD9	

Note

- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL	PINNING		
ITPE NUMBER	SIMPLIFIED OUTLINE AND STMBOL	PIN	DESCRIPTION	
PEMH9		1	emitter TR1	
PIMH9	□ 6 □ 5 □ 4 □ □ □ □ □	2	base TR1	
PUMH9		3	collector TR2	
	R1 R2 J	4	emitter TR2	
	TR1	5	base TR2	
	$ \qquad \qquad \qquad \qquad \qquad \qquad \qquad $	6	collectorTR1	
	1 2 3			
	Top view MHC049			

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ORDERING INFORMATION

TYPE NUMBER	PACKAGE				
TYPE NUMBER	NAME	DESCRIPTION	VERSION		
РЕМН9	_	plastic surface mounted package; 6 leads	SOT666		
PIMH9	 plastic surface mounted package; 6 leads 		SOT457		
PUMH9	 plastic surface mounted package; 6 leads 		SOT363		

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transis	tor				
V _{CBO}	collector-base voltage	open emitter	_	50	V
V _{CEO}	collector-emitter voltage	open base	_	50	V
V _{EBO}	emitter-base voltage	open collector	_	10	V
Vi	input voltage			. 40	.,
	positive negative		-	+40 -10	V
Io	output current		_	100	mA
I _{CM}	peak collector current		_	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
	SOT363	note 1	_	200	mW
	SOT457	note 1	_	300	mW
	SOT666	notes 1 and 2	_	200	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C
Per device					
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$			
	SOT363	note 1	_	300	mW
	SOT457	note 1	_	600	mW
	SOT666	notes 1 and 2	_	300	mW

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Notes

- 1. Device mounted on an FR4 printed-circuit board, single-sided copper, standard footprint.
- 2. Reflow soldering is the only recommended soldering method.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
Per transist	or			
R _{th(j-a)}	thermal resistance from junction to ambient	T _{amb} ≤ 25 °C		
	SOT363	note 1	625	K/W
	SOT457	note 1	417	K/W
	SOT666	notes 1 and 2	625	K/W
Per device	•	•		
R _{th(j-a)}	thermal resistance from junction to ambient	T _{amb} ≤ 25 °C		
	SOT363	note 1	416	K/W
	SOT457	note 1	208	K/W
	SOT666	notes 1 and 2	416	K/W

Notes

- 1. Device mounted on an FR4 printed-circuit board, single-sided copper, standard footprint.
- 2. Reflow soldering is the only recommended soldering method.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0 A	_	_	100	nA
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0 A	_	_	1	μΑ
		$V_{CE} = 30 \text{ V}; I_{B} = 0 \text{ A}; T_{j} = 150 ^{\circ}\text{C}$	_	_	50	μΑ
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A	_	_	150	μΑ
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$	100	_	_	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 5 \text{ mA}; I_B = 0.25 \text{ mA}$	_	_	100	mV
$V_{i(off)}$	input-off voltage	$V_{CE} = 5 \text{ V}; I_{C} = 100 \mu\text{A}$	_	0.7	0.5	V
$V_{i(on)}$	input-on voltage	$V_{CE} = 0.3 \text{ V}; I_{C} = 1 \text{ mA}$	1.4	0.8	_	V
R1	input resistor		7	10	13	kΩ
R2 R1	resistor ratio		3.7	4.7	5.7	
Сс	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	_	_	2.5	pF

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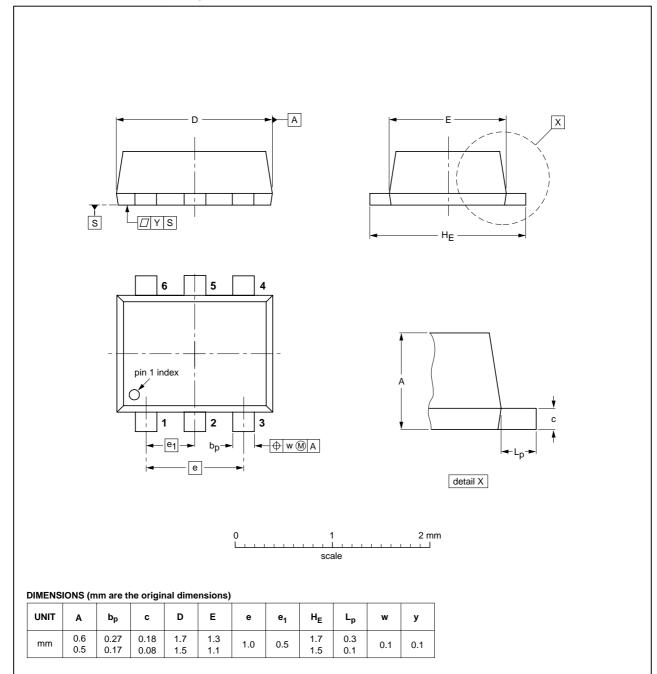
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PACKAGE OUTLINES

Plastic surface-mounted package; 6 leads

SOT666



	REFERENCES			EUROPEAN ISSUE DATE		
IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
					-04-11-08- 06-03-16	
-	IEC	IEC JEDEC	IEC JEDEC JEITA	IEC JEDEC JEITA	IEC JEDEC JEITA PROJECTION	

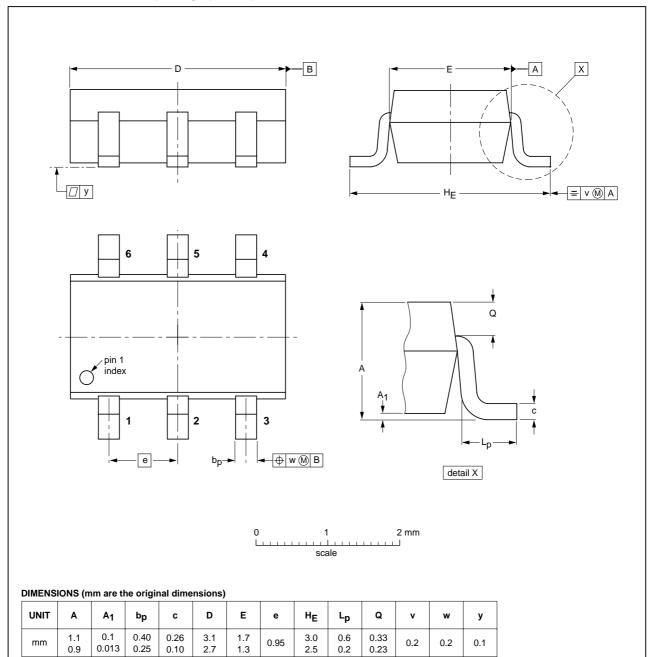
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NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

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Plastic surface-mounted package (TSOP6); 6 leads

SOT457



OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT457			SC-74			-05-11-07- 06-03-16	

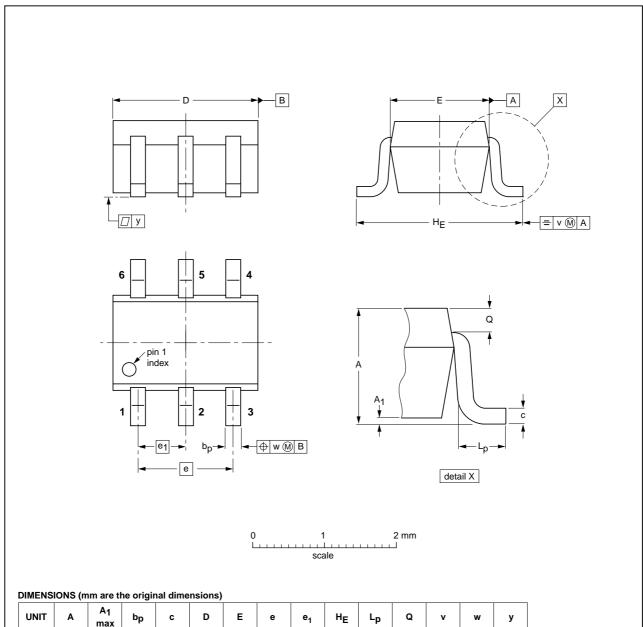
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NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

PIMH9; PUMH9; PEMH9

Plastic surface-mounted package; 6 leads

SOT363



OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	135UE DATE
SOT363			SC-88		04-11-08 06-03-16

0.65

0.45

0.25

0.2

0.2

0.1

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0.25

0.10

1.35

1.3

1.1

0.1

mm

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
- 2. The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

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